## CENTRE FOR RESEARCH AND CONSULTANCY, HINDUSTAN INSTITUTE OF TECHNOLOGY AND SCIENCE RECRUITEMENT OF JUNIOR RESEARCH FELLOWSHIP

Date: 20-12-2022

Ref: No. HITS/AERO/SIMCRASH/PA/2022-2023 Vacancy Position: Junior Research fellowship - 1

Applications are invited from Indian Nationals for a temporary position of Junior research fellowship for a period of three years as per the details given below, for the research project under the Principal investigator **Dr. K. Ramajeyathilagam, Senior Professor, Structural Impact and Crash Simulation Centre (SIMCRASH), School of Aeronautical Sciences, Hindustan University, Padur, Chennai-603103,** Tamil Nadu, Email: krama@hindustanuniv.ac.in and tsivag@hindustanuniv.ac.in

1	Title of the Project	:	Experimental and Numerical investigations on the failures of metallic and composite structures to hail –ice impact	
2	Funding Agency for the Project	•••	Aeronautics R&D Board DRDO, Ministry of Defence	
3	Project designation		Junior Research Fellowship	
4	Number of positions	••	One	
5	Duration		36 months	
6	Qualification	•	<ol> <li>Essential Qualification         <ol> <li>M.Tech / M.E in Aeronautics / Mechanical/ Composites with the bachelor degree in Aeronautical / Mechanical Engineering.</li> </ol> </li> <li>Desirable Qualification         <ol> <li>Knowledge of LSDYNA explicit code and FEM Analysis preferred.</li> </ol> </li> <li>Knowledge of Composite Materials &amp; Composite Product design for underwater applications preferred.</li> </ol>	
7	Consolidated Emoluments throughout the tenure		Rs.35650/-	

The candidate selected as Project Associate is eligible to register for pursuing Ph.D by Research programme as per HITS regulations and selection procedures.

- (i) Interested candidates should submit their applications with the following documents to the office of the above mentioned Principal Investigator through Registered Post.
- (ii) Application should be furnished only in the prescribed format given.
- (iii) Mention experience including research, industrial field and others.
- (iv) Enclose attested copies of degree certificate and experience certificate.
- (v) Shortlisted candidates will be called for the interview. Candidates shall bring along with them the original certificates at the time of interview for verification.
- (vi) Please note that no TA/DA is admissible for attending the interview.
- (vii) The last date of submission of duly filled in application through mail and post is 13-01-2023. The application should be submitted only in the prescribed format.
- (viii) The selected candidate should join within 7 days of receiving appointment order.

## CENTRE FOR RESEARCH AND CONSULTANCY HINDUSTAN INSTITUTE OFTECHNOLOGY AND SCIENCE

## ADVERTISEMENT IN HITS WEBSITE FOR RECRUITEMENT OF JUNIOR RESEARCH FELLOWSHIP

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9. Project Title					
10.Name of the Po	st applied for				
Academic Career:	Enclose photo copie	es of the quali	fying degree c	ertificates and	d mark
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Any other					
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12.	Work Experience, if any	

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List of Enclosures:	1) 2) 3) 4)	